https://www.protoexpress.com/hdi/hdi-tools-design-assistant-options-dtl.jsp?data=%2Fl7EMm9LjOSjqcayMmc4BtyXhtvUjGoNVKtNutPl6iUS1uf%2F

HDI Stackup Planner — Detailed Report for HSP-106815 Option B



 Customer Input

 Part Number/ Rev
 : harley/ a

 PCB Size
 : 1.3 inches X 1.72 inches

 Number of layers
 : 10
 PCB Thickness
 : 0.062 inches

 Material
 : NP175
 Outer Layer
 : Signal

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MicroV	ias depicted by		Finished Copper Weight	Finished Thickness (inches)	Impedance Calculator
	SOLDER MASK			0.0005	
L-1	TOP SIGNAL		1 Oz	0.0014	NEED IMPEDANCE CALCULATIONS
	DIELECTRIC			0.0035	
L-2	PLANE		0.5 Oz	0.0007	
	DIELECTRIC			0.0040	
L-3	SIGNAL	A 100 A 100 A	0.5 Oz	0.0007	NEED IMPEDANCE CALCULATIONS
	DIELECTRIC			0.0035	
L-4	SIGNAL	A-100	0.5 Oz	0.0007	NEED IMPEDANCE CALCULATIONS
	DIELECTRIC			0.0040	
L-5	PLANE		0.5 Oz	0.0007	
	DIELECTRIC			0.0225	
L-6	SIGNAL	A-100	0.5 Oz	0.0007	NEED IMPEDANCE CALCULATIONS
	DIELECTRIC			0.0040	
L-7	PLANE		0.5 Oz	0.0007	
	DIELECTRIC			0.0035	
L-8	PLANE		0.5 Oz	0.0007	
	DIELECTRIC			0.0040	
L-9	PLANE		0.5 Oz	0.0007	
	DIELECTRIC			0.0035	
L-10	BOTTOM SIGNAL		1 Oz	0.0014	NEED IMPEDANCE CALCULATIONS
	SOLDER MASK			0.0005	
			Total Thickn	ness 0.0619 (inches)	

Customer Saved Impedance Results					
Layer	Impedance Model	Impedance (ohms)	Trace (mils)	Space (mils)	Delete
		No impedance calculations yet!			

Stackup Details					
Number of Layers	Number of Signal Layers	Number of Sequential Laminations	Number of Plane Layers	Maximum Number of Laser Drills	Mechanical Drills
10	5	0	5	2	1

Via Set Information

Technology Parameters and Cost Index				
PCB TECHNOLOGY LEVELS	Level 1	Level 2	Level 3	Level 4
Mechanical Micro via Drill diameter (in mils)	8.00	8.00	7.00	6.00
Mechanical Micro via Pad diameter (in mils)	16.00	14.00	13.00	12.00
Micro Via Drill Diameter (in mils)	6	6	6	6
Micro Via Pad Diameter (in mils)	14	12	12	12
Trace Width Top Layer (in mils)	5.00	4.50	4.00	4.00
Trace width Inner Buildup Layers (in mils)	4.50	4.00	3.50	3.00
Trace Width Inner Core Layers (in mils)	4.50	4.00	3.50	3.00
Trace Width Bottom Layer (in mils)	5.00	4.50	4.00	4.00
Cost Index	2.7	3.2	4.0	5.0

This stack up supports the following via set L1-L2 L1-L10 L9-L10